



Features and Benefits

- Small DIP8 package with 8 to 24 W power output 230 VAC
- Current Mode PWM control with 67 kHz switching frequency
- Built-in Random Switching function, reducing EMI noise, and simplifying EMI filters, and therefore reducing cost
- Built-in Slope Compensation function, avoiding subharmonic oscillation
- Built-in Auto Standby function (Input Power, P_{IN} < 25 mW at no load)
- Normal operation: PWM mode
- Light load operation: Standby mode (burst oscillation)
- Built-in Audible Noise Suppression function during Standby mode
- Built-in Startup Circuit, reducing power consumption in standby operation, and eliminating external components.
- Bias-Assist function, improving startup operation, suppressing V_{CC} voltage drop in operation, and allowing use of smaller V_{CC} capacitor

Continued on the next page...

Package: 8-pin DIP



Not to scale

Description

The STR-A60xxM series are power ICs for switching power supplies, incorporating a power MOSFET and a current mode PWM controller IC. Including a startup circuit and a standby function in the controller, the product achieves low power consumption, low standby power, and high cost-effectiveness power supply systems with few external components.

The STR-A60xxM internal MOSFET has a V_{DSS} of 650 V(min) or 800 V(min), and an $R_{DS(on)}$ of 1.9 to 19.2 Ω with a frequency of 67 kHz. Power output is rated at 8 to 24 W at 230 VAC input and 5 to 20 W at wide input range (85 to 265 VAC).

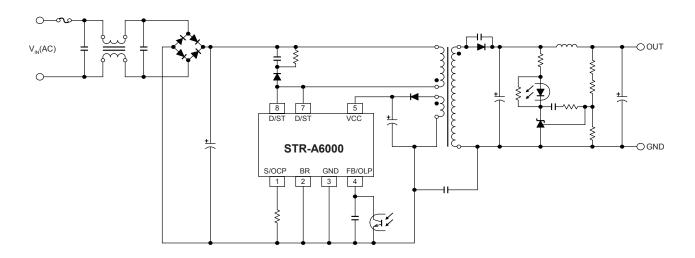
The device is provided in an industry-standard DIP-8 package, with pin 6 removed for increased isolation.

Applications:

For switching power supplies used in:

- Battery chargers for cell phones, digital cameras, video cameras, shavers, emergency lights
- Stand-by power for LCD TVs, desktop PCs, LB Printers, audio equipment
- Small switched-mode power supplies for inkjet printers, DVD/CD players, set-top boxes
- Auxiliary power supplies for A/C, refrigerators, washers, dish washers, and other white goods

Typical Application



Current Mode Control PWM Regulator IC For Switching Power Supplies

Features and Benefits (continued)

- Built-in Leading Edge Blanking function
- Built-in High Speed Latch Release function, releasing the latch shutdown immediately at turning off AC supply
- Two-chip structure, with a controller and a power MOSFET with guaranteed avalanche energy available to simplify surge absorber circuits
- Protection functions:
- Brown-In and Brown-Out Protection function: auto-restart, prevention of excess input current and heat rise at low input voltage
- Overcurrent Protection function (OCP): pulse-by-pulse built-in compensation circuit to minimize OCP point variation on AC input voltage
- Overload Protection function (OLP): auto-restart, built-in timer, reduces heat during overload condition, and no external components required
- Overvoltage Protection function (OVP): latched shutdown
- Thermal Shutdown Protection function (TSD): shutdown latches device off to prevent continuous oscillation

Selection Guide

| Part Number | f _{osc} (kHz) | MOSFET V _{DSS} (min) | R _{DS(on)} (max) | Р _{оит} * (W) | | | | | | | | | | | | | |
|-------------|---------------------------|----------------------------------|------------------------------|---------------------------|------|-------------------------|--------------------|--|--|--|--|--|--|--|--|--|--|
| | (KIIZ) | (V) | (Ω) | 230 V | Wide | _ | _ | | | | | | | | | | |
| STR-A6051M | | | 3.95 | 16 | 12 | | 50 pieces per tube | | | | | | | | | | |
| STR-A6052M | 67 | 650 | 2.8 | 20 | 16 | DIDO with hin 6 removed | | | | | | | | | | | |
| STR-A6053M | 67 | | 1.9 | 24 | 20 | DIP8 with pin 6 removed | | | | | | | | | | | |
| STR-A6079M | | 800 | 19.2 | 8 | 5 | | | | | | | | | | | | |

^{*} The listed output power is based on the package thermal ratings, and the peak output power can be 120% to 140% of the value stated here. At low output voltage and short duty cycle, the output power may be less than the value stated here.





Current Mode Control PWM Regulator IC For Switching Power Supplies

Absolute Maximum Ratings¹ Valid at T_A = 25°C, unless otherwise specified

| Characteristic | Symbol | Notes | | Terminals | Rating | Unit |
|--|--------------------|--|------------|-----------|------------|------|
| | | | STR-A6051M | 8 – 1 | 2.5 | Α |
| Drain Current? | | Single pulse | STR-A6052M | 8 – 1 | 3.0 | Α |
| Drain Current ² | I _{Dpeak} | | STR-A6053M | 8 – 1 | 4.0 | Α |
| | | | STR-A6079M | 8 – 1 | 1.2 | Α |
| | | Single pulse, V _{DD} = 99 V, L = 20 mH | STR-A6051M | 8 – 1 | 47 | mJ |
| | E _{AS} | | STR-A6052M | 8 – 1 | 62 | mJ |
| | | | STR-A6053M | 8 – 1 | 86 | mJ |
| Single Dules Avalenche Energy3 | | | STR-A6079M | 8 – 1 | 7 | mJ |
| Single Pulse Avalanche Energy ³ | I _{Lpeak} | | STR-A6051M | 8 – 1 | 2.0 | Α |
| | | Single pulse, V _{DD} = 99 V, L = 20 mH | STR-A6052M | 8 – 1 | 2.3 | Α |
| | | | STR-A6053M | 8 – 1 | 2.7 | Α |
| | | | STR-A6079M | 8 – 1 | 1.2 | Α |
| S/OCP Terminal Voltage | V _{OCP} | | | 1 – 3 | –2 to 6 | V |
| Controller IC (MIC) Supply Input Voltage | V _{CC} | | | 5 – 3 | 32 | V |
| FB/OLP Terminal Voltage | V _{FB} | | | 4 – 3 | -0.3 to 14 | V |
| FB/OLP Terminal Sink Current | I _{FB} | | | 4 – 3 | 1.0 | mA |
| BR Terminal Voltage | V _{BR} | | | 2-3 | –0.3 to 7 | V |
| BR Terminal Sink Current | I _{BR} | | | 2-3 | 1.0 | mA |
| MOSFET Power Dissipation ⁴ | P _{D1} | Mounted on a 15 mm × 15 mm PCB | | 8 – 1 | 1.35 | W |
| Controller IC (MIC) Power Dissipation | P _{D2} | | | 5 – 3 | 1.2 | W |
| Operating Ambient Temperature | T _{OP} | Maximum recommended internal leadframe temperature, T _F (max) = 115°C | | | –20 to 125 | °C |
| Storage Temperature | T _{stg} | | | _ | -40 to 125 | °C |
| Channel Temperature | T _{ch} | | | _ | 150 | °C |

¹Current characteristics are defined based on IC as sink (+), or source (-).



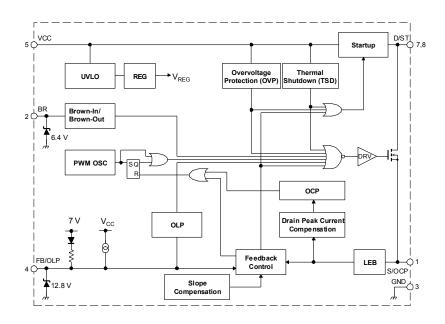


²Refer to MOSFET Safe Operating Area Curve.

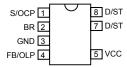
³Refer to MOSFET Avalanche Energy Derating Coefficient Curve.

⁴Refer to MOSFET Temperature versus Power Dissipation Curve.

Functional Block Diagram



Pin-out Diagram



Terminal List Table

| Number | Name | Function |
|--------|--------|---|
| 1 | S/OCP | MOSFET source, and input for Overcurrent Protection detection signal |
| 2 | BR | Input for Brown-In and Brown-Out Protection detection voltage |
| 3 | GND | Ground |
| 4 | FB/OLP | Input for constant voltage control signal, and input for Overload Protection signal |
| 5 | VCC | Input for power supply for control circuit |
| 6 | _ | (Pin removed) |
| 7, 8 | D/ST | MOSFET drain, and input for startup current |





Current Mode Control PWM Regulator IC For Switching Power Supplies

Electrical Characteristics¹ Valid at V_{CC} = 18 V, T_A = 25°C, unless otherwise specified

| Characteristic | Symbol | Terminal | Min. | Тур. | Max. | Unit |
|---|------------------------|----------|------|------|------|-------|
| Operation Start Voltage | V _{CC(ON)} | 5 – 3 | 13.8 | 15.3 | 16.8 | V |
| Operation Stop Voltage ² | V _{CC(OFF)} | 5 – 3 | 7.3 | 8.1 | 8.9 | V |
| Circuit Current in Operation | I _{CC(ON)} | 5 – 3 | _ | - | 2.5 | mA |
| Minimum Startup Voltage | V _{ST(ON)} | 5 – 3 | _ | 38 | _ | V |
| Startup Current | I _{STARTUP} | 5 – 3 | -3.7 | -2.5 | -1.5 | mA |
| Startup Current Supply Threshold Voltage ² | V _{CC(BIAS)} | 5 – 3 | 8.5 | 9.5 | 10.5 | V |
| Average Switching Frequency | f _{OSC(av)} | 8 – 3 | 60 | 67 | 74 | kHz |
| Switching Frequency Variance Range | Δf | 8 – 3 | _ | 5 | _ | kHz |
| Maximum Duty Cycle | D _{MAX} | 8 – 3 | 77 | 83 | 89 | % |
| Minimum On-Time | t _{ON(MIN)} | _ | _ | 540 | - | ns |
| Leading Edge Blanking Time | t _{BW} | _ | - | 340 | _ | ns |
| OCP Compensation Coefficient | D _{PC} | - | - | 22 | _ | mV/μs |
| Maximum Duty Cycle for OCP Compensation | D _{DPC} | - | _ | 36 | _ | % |
| OCP Threshold Voltage at Zero Duty Cycle | V _{OCP(L)} | 1 – 3 | 0.70 | 0.78 | 0.86 | V |
| OCP Threshold Voltage at 36% Duty Cycle | V _{OCP(H)} | 1 – 3 | 0.81 | 0.9 | 0.99 | V |
| Maximum Feedback Current | I _{FB(MAX)} | 4 – 3 | -340 | -230 | -150 | μΑ |
| Minimum Feedback Current | I _{FB(MIN)} | 4 – 3 | -30 | -15 | -7 | μΑ |
| Oscillation Stop FB/OLP Voltage | V _{FB(OFF)} | 4 – 3 | 0.85 | 0.95 | 1.05 | V |
| OLP Threshold Voltage | V _{FB(OLP)} | 4 – 3 | 7.3 | 8.1 | 8.9 | V |
| OLP Delay Time | t _{OLP} | 4 – 3 | 54 | 68 | 82 | ms |
| Operation Current After OLP | I _{CC(OLP)} | 5 – 3 | _ | 300 | 600 | μΑ |
| FB/OLP Terminal Clamp Voltage | V _{FB(CLAMP)} | 4 – 3 | 11 | 12.8 | 14 | V |
| Brown-In Threshold Voltage | V _{BR(IN)} | 2 – 3 | 5.2 | 5.6 | 6 | V |
| Brown-Out Threshold Voltage | V _{BR(OUT)} | 2 – 3 | 4.45 | 4.8 | 5.15 | V |
| BR Terminal Clamp Voltage | V _{BR(CLAMP)} | 2 – 3 | 6 | 6.4 | 7 | V |
| BR Function Disabling Threshold | V _{BR(DIS)} | 2 – 3 | 0.3 | 0.48 | 0.7 | V |
| OVP Threshold Voltage | V _{CC(OVP)} | 5 – 3 | 26 | 29 | 32 | V |
| Latch Circuits Sustaining Current ³ | I _{CC(LATCH)} | 5 – 3 | _ | 700 | _ | μΑ |
| Thermal Shutdown Operating Temperature | T _{J(TSD)} | 5 – 3 | 135 | _ | _ | °C |

¹Current characteristics are defined based on IC as sink (+), or source (-).





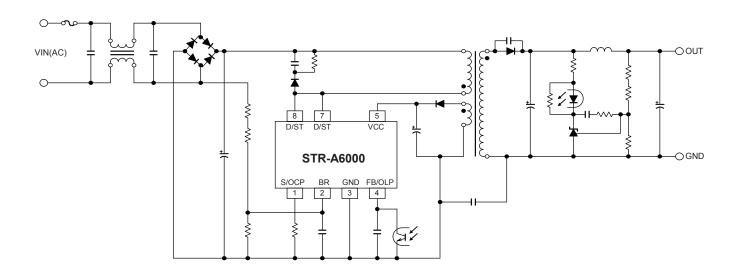
 $^{^{2}}V_{CC(BIAS)} > V_{CC(OFF)}$.

³A latch circuit is a circuit operated with Overvoltage Protection (OVP) and/or Thermal Shutdown Protection (TSD) in operation.

MOSFET Electrical Characteristics Valid at T_A = 25°C, unless otherwise specified

| Characteristic | Symbol | Device | Terminal | Min. | Тур. | Max. | Unit |
|------------------------------------|---------------------|-------------------|----------|------|------|------|------|
| | | STR-A6051M | 8 – 1 | 650 | _ | _ | V |
| Duein to Course Burelideum Veltage | | STR-A6052M | 8 – 1 | 650 | _ | _ | V |
| Drain-to-Source Breakdown Voltage | V_{DSS} | STR-A6053M | 8 – 1 | 650 | _ | _ | V |
| | | STR-A6079M | 8 – 1 | 800 | _ | _ | V |
| Drain Leakage Current | I _{DSS} | _ | 8 – 1 | _ | _ | 300 | μΑ |
| | | STR-A6051M | 8 – 1 | _ | _ | 3.95 | Ω |
| On Desistance | | STR-A6052M | 8 – 1 | _ | _ | 2.8 | Ω |
| On-Resistance | R _{DS(on)} | STR-A6053M | 8 – 1 | _ | _ | 1.9 | Ω |
| | | STR-A6079M | 8 – 1 | _ | _ | 19.2 | Ω |
| | | STR-A6051M | 8 – 1 | _ | _ | 250 | ns |
| Cuitabina Tina | | STR-A6052M | 8 – 1 | _ | _ | 250 | ns |
| Switching Time | t _f | STR-A6053M | 8 – 1 | _ | _ | 400 | ns |
| | | STR-A6079M | 8 – 1 | _ | _ | 250 | ns |
| Thermal Resistance* | R _{echC} | R _{0chC} | _ | _ | _ | 22 | °C/W |

 $^{^{\}star}$ Case temperature, T_{C} , is defined at the center of surface on the branded side of the package.

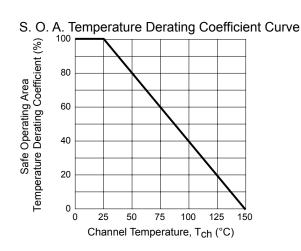


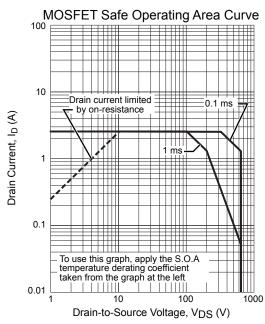
Typical application circuit example. Brown-in/Brown-out function enabled by connecting the BR terminal to a resistive divider



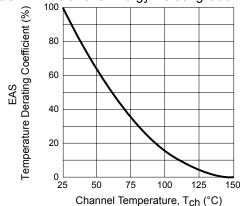


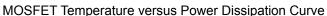
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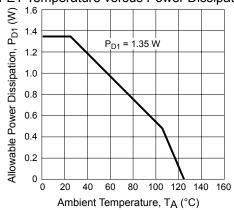


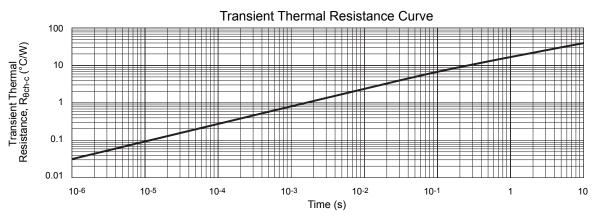


MOSFET Avalanche Energy Derating Coefficient Curve





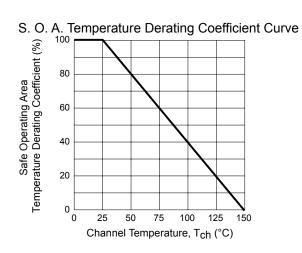


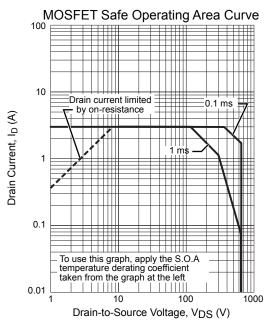




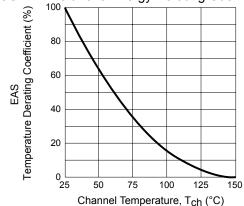


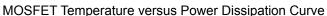
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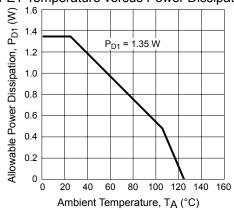


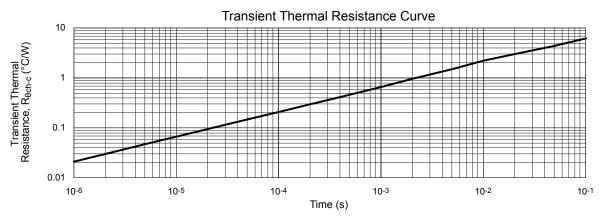


MOSFET Avalanche Energy Derating Coefficient Curve





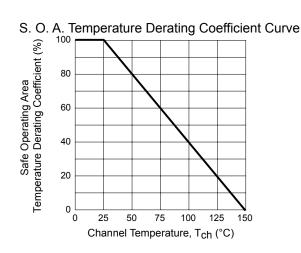


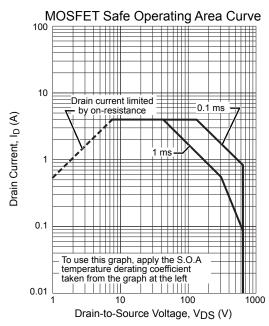




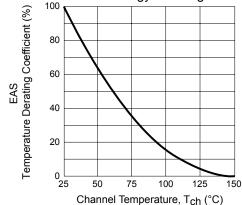


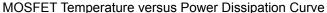
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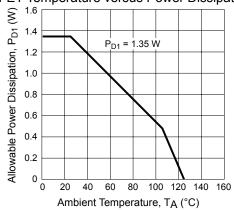


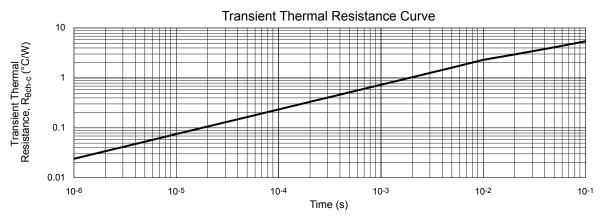


MOSFET Avalanche Energy Derating Coefficient Curve









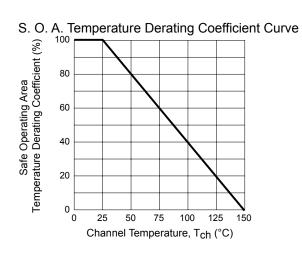
Allegro MicroSystems, Inc. 115 Northeast Cutoff

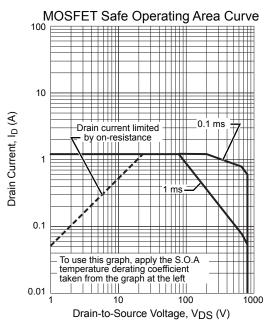
Worcester, Massachusetts 01615-0036 U.S.A 1.508.853.5000; www.allegromicro.com



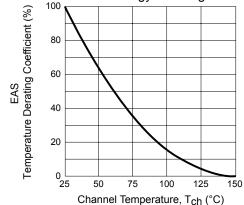


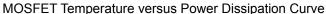
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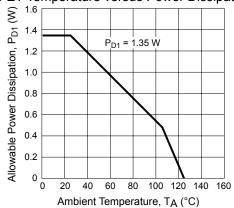


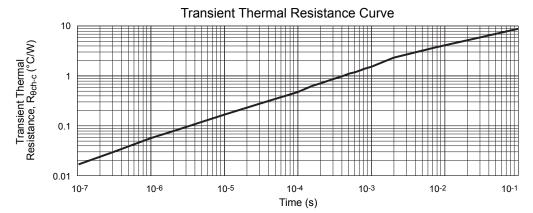


MOSFET Avalanche Energy Derating Coefficient Curve





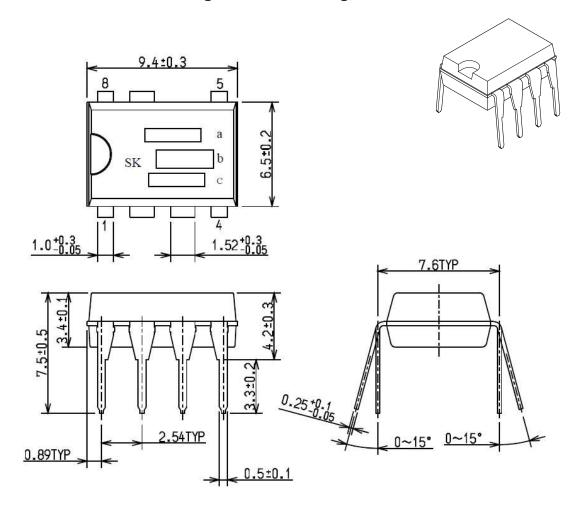








Package Outline Drawing, DIP-8



Material of terminal: Cu Treatment of terminal: Solder plating (Pb-free) Weight: Approximately 0.51 g Unit: mm



Leadframe plating Pb-free. Device composition compliant with the RoHS directive.

- a. Type Number: A60**
- b. Lot Number:

1st letter: Last digit of year

2nd letter: Month

1 to 9 for Jan. to Sept.

O for Oct.

N for Nov.

D for Dec.

3rd letter: Week

c. Sanken Registration Number

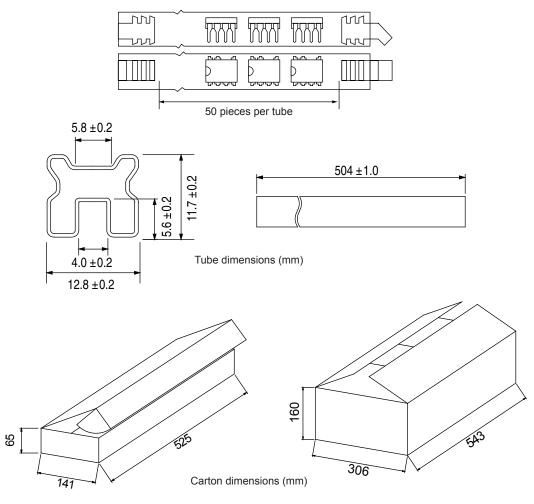
Appearance: The body shall be clean and shall not bear any stain, rust, or flaw.

Marking: The type number and lot number shall be clearly marked.





Packing Specifications



50 tubes per inner carton (maximum) 2500 pieces maximum per inner carton 4 inner cartons per outer carton (maximum) 10,000 pieces maximum per outer carton





Current Mode Control PWM Regulator IC For Switching Power Supplies

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (around 40% to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of products that have been stored for a long time.

Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between the product pins, and wrong connections.

Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce excess stress.
- Volatile-type silicone greases may crack after long periods of time, resulting in reduced heat radiation effect. Silicone grease with low consistency (hard grease) may cause cracks in the mold resin when screwing the product to a heatsink.
- Our recommended silicone greases for heat radiation purposes, which will not cause any adverse effect on the product life, are indicated below:

| Туре | Suppliers |
|--------|---|
| G746 | Shin-Etsu Chemical Co., Ltd. |
| YG6260 | Momentive Performance Materials Holding, Inc. |
| SC102 | Dow Corning Toray Co., Ltd. |

Soldering

- Leadframe temperature, T_F, should not exceed 115°(max)
- When soldering the products, please be sure to minimize the working time, within the following limits:

260±5°C 10 s

350±5°C 3 s (solder iron)

 To avoid internal chip damage, soldering on each of the lead-pins should be at a distance of at least 1.5 mm away from the body of the products.

Electrostatic Discharge

- When handling the products, the operator must be grounded. Grounded wrist straps worn should have at least 1 M Ω of resistance from the operator to ground to prevent shock hazard, and it should be placed near the operator.
- Workbenches where the products are handled should be grounded and be provided with conductive table and floor mats.
- When using measuring equipment such as a curve tracer, the equipment should be grounded.
- When soldering the products, the head of soldering irons or the solder bath must be grounded in other to prevent leak voltages generated by them from being applied to the products.
- The products should always be stored and transported in Sanken shipping containers or conductive containers, or be wrapped in aluminum foil.





Current Mode Control PWM Regulator IC For Switching Power Supplies

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